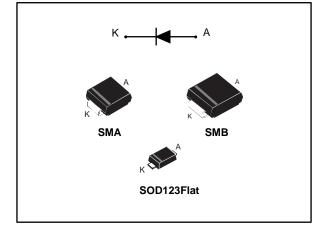


STPS1L40-Y

Automotive low drop power Schottky rectifier

Datasheet - production data



Features



- AEC-Q101 qualified
- Very small conduction losses
- Negligible switching losses
- Low forward voltage drop
- Surface mount miniature packages
- Avalanche capability specified
- PPAP capable

Description

Single chip Schottky rectifiers suited to switched mode power supplies and high frequency DC to DC converters.

Packaged in SOD123Flat, SMA and SMB, this device is especially intended for surface mounting and used in low voltage, high frequency inverters, free-wheeling and polarity protection in automotive applications.

Table 1: Device summary				
Symbol	Value			
lf(AV)	1 A			
Vrrm	40 V			
V _F (typ.)	0.37 V			
T _j (max.)	175 °C			

October 2016

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This is information on a product in full production.

1 Characteristics

Table 2: Absolute ratings (limiting values at 25 °C, unless otherwise specified)

Symbol	Parameter	Value	Unit	
Vrrm	Repetitive peak reverse voltage	T _j = -40 °C to +175 °C	40	V
1	Average forward current	SMA/SMB: T _L = 155 °C	1	۸
IF(AV)	$\bar{\mathbf{D}} = 0.5$, square wave	SOD123Flat: T _L = 160 °C	I	A
	Surge non repetitive forward current,	SMA/SMB	60	А
IFSM	t _p = 10 ms sinusoidal	SOD123Flat	50	A
PARM	Repetitive peak avalanche power $t_p = 10 \ \mu s, T_j = 125 \ ^{\circ}C$		65	W
T _{stg}	Storage temperature range	-65 to +175		
Tj	Operating junction temperature range ⁽¹	-40 to +175		

Notes:

 $^{(1)}(dP_{tot}/dT_j) < (1/R_{th(j-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 3: Thermal parameters	nal parameters	Therma	3:	Table
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Symbol	Parameter	Max. value	Unit	
		SMA	30	
Rth(j-l)	R _{th(j-l)} Junction to lead	SMB	25	°C/W
		SOD123Flat	20	

Table 4: Static	electrical	characteristics
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Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
L (1)	I _R ⁽¹⁾ Reverse leakage current	T _j = 25 °C	Vr = Vrrm	-		35	μA
IR ⁽¹⁾		Tj = 125 °C		-	6	10	mA
VF ⁽²⁾	Forward valtage drap	Tj = 25 °C	IF = 1 A	-		0.50	V
VF ⁽²⁾ Forward voltage dro	Forward voltage drop	Tj = 125 °C	IFEIA	-	0.37	0.42	v

Notes:

⁽¹⁾Pulse test: t_p = 5 ms, δ < 2% ⁽²⁾Pulse test: t_p = 380 µs, δ < 2%

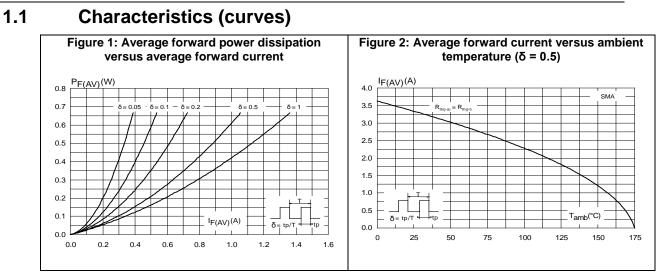
To evaluate the conduction losses, use the following equation:

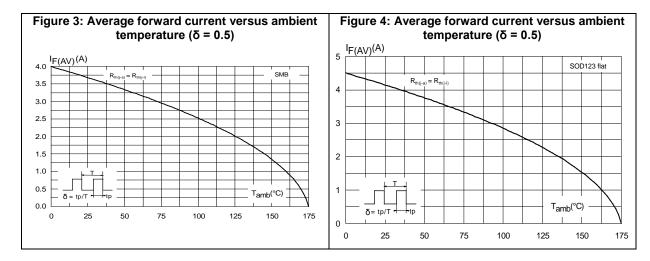
 $P = 0.23 \text{ x } I_{F(AV)} + 0.19 \text{ x } I_{F^{2}(RMS)}$

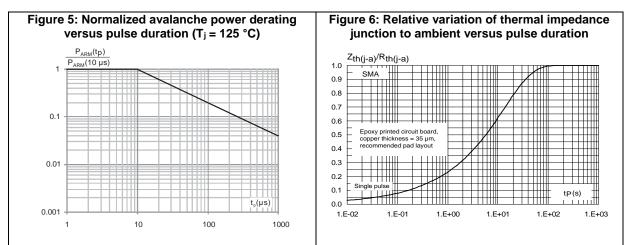
For more information, please refer to the following application notes related to the power losses.

- AN604 (Calculation of conduction losses in a power rectifier)
- AN4021 (Calculation of reverse losses in a power diode)





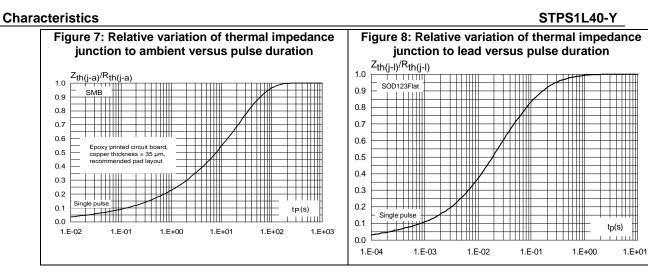


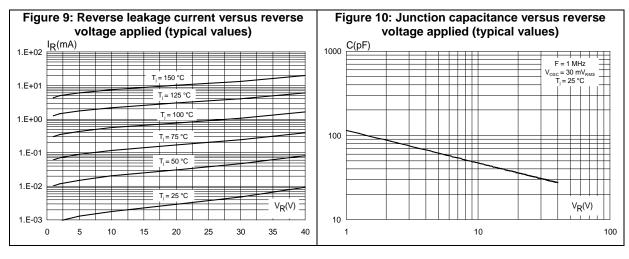


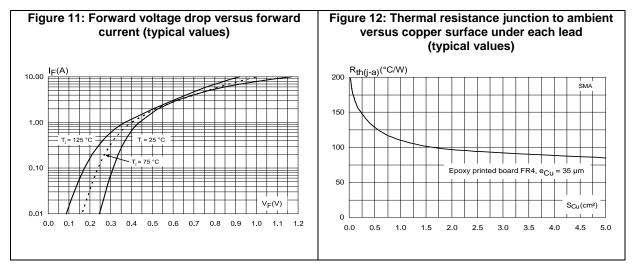
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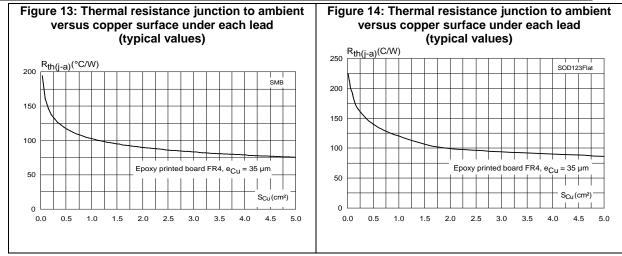
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Characteristics





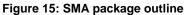
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2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)

2.1 SMA package information



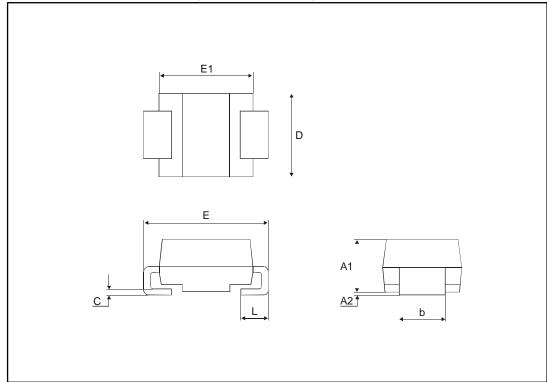


Table 5: SMA package mechanical data

Ref.	Millir	neters	Inc	hes
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.097
A2	0.05	0.20	0.002	0.008
b	1.25	1.65	0.049	0.065
с	0.15	0.40	0.006	0.016
D	2.25	2.90	0.089	0.114
E	4.80	5.35	0.189	0.211
E1	3.95	4.60	0.156	0.181
L	0.75	1.50	0.030	0.059

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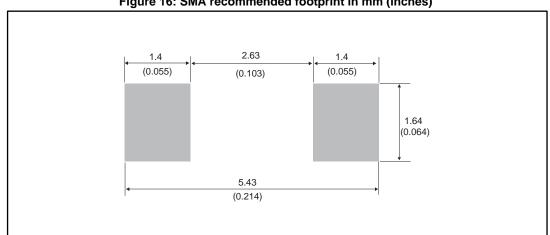
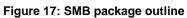
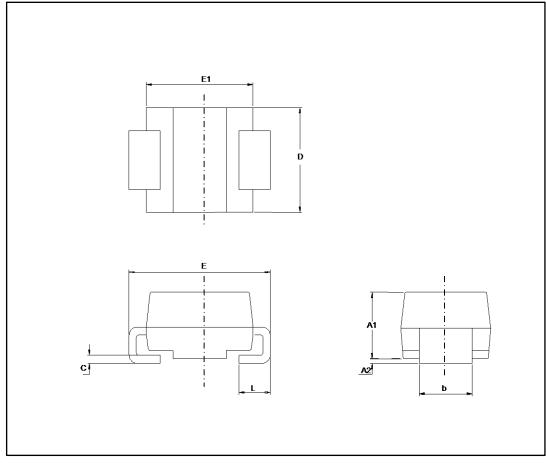


Figure 16: SMA recommended footprint in mm (inches)



2.2 SMB package information

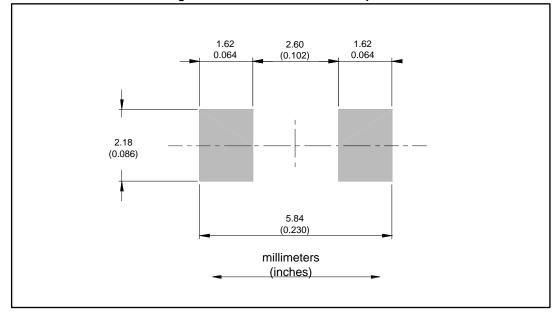




	Dimensions			
Ref.	Millin	neters	Inc	hes
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.0748	0.0965
A2	0.05	0.20	0.0020	0.0079
b	1.95	2.20	0.0768	0.0867
с	0.15	0.40	0.0059	0.0157
D	3.30	3.95	0.1299	0.1556
E	5.10	5.60	0.2008	0.2205
E1	4.05	4.60	0.1594	0.1811
L	0.75	1.50	0.0295	0.0591









2.3 SOD123Flat package information



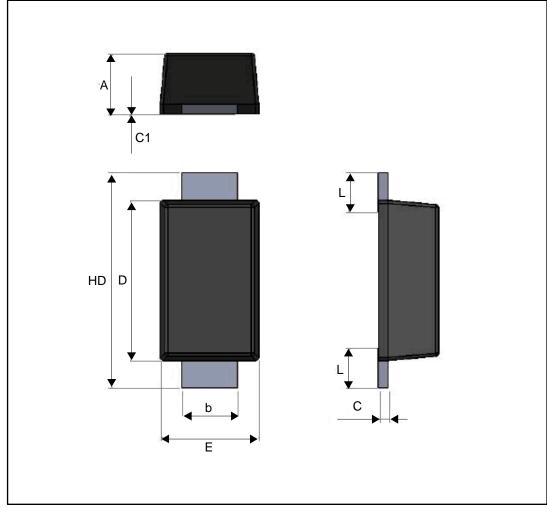
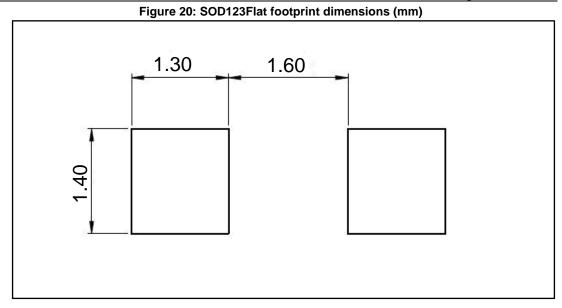


Table 7: SOD123Flat package mechanical data

	Dimensions				
Ref.		Millimeters			
	Min.	Тур.	Max.		
A	0.86	0.98	1.10		
b	0.80	0.90	1.00		
с	0.08	0.15	0.25		
c1	0.00		0.10		
D	2.50	2.60	2.70		
E	1.50	1.60	1.80		
HD	3.30	3.50	3.70		
L	0.45	0.65	0.85		







3 Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS1L40AY	GB4Y	SMA	68 mg	5000	Tape and reel
STPS1L40UY	GC4Y	SMB	107 mg	2500	Tape and reel
STPS1L40ZFY	1Y4	SOD123Flat	12.5 mg	3000	Tape and reel

Table 8: Ordering information

4 Revision history

Table 9: Document revision history

Date	Revision	Changes
21-Oct-2011	1	First issue.
01-Oct-2016	2	Added SOD123Flat package.



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